

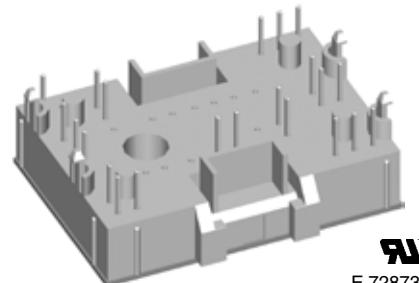
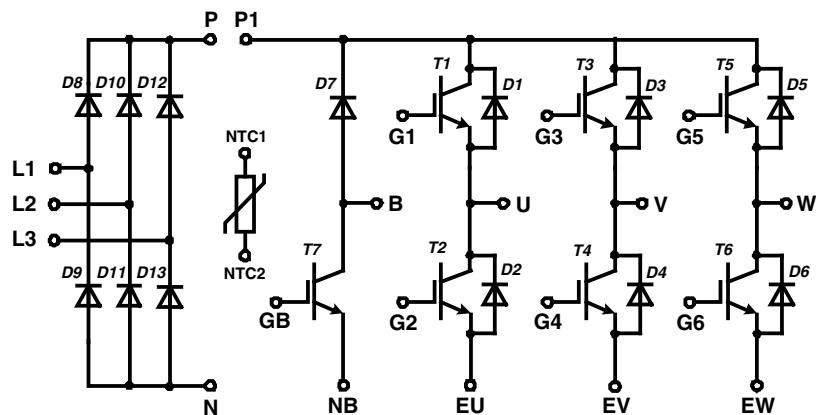
# Converter - Brake - Inverter Module

## Low Loss Trench IGBT

Three Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{DAVM25} = 90 \text{ A}$	$I_{C25} = 29 \text{ A}$	$I_{C25} = 29 \text{ A}$
$I_{FSM} = 300 \text{ A}$	$V_{CE(sat)} = 1.7 \text{ V}$	$V_{CE(sat)} = 1.7 \text{ V}$

**Part name** (Marking on product)

MITB15WB1200TMH



Pin configuration see outlines.

### Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Inverter with low loss Trench IGBTs
  - very low saturation voltage
  - positive temperature coefficient
  - short tail current
- Epitaxial free wheeling diodes with hiperfast soft reverse recovery
- Temperature sense included

### Application:

- AC motor drives
- Pumps, Fans
- Washing machines
- Air-conditioning system
- Inverter and power supplies

### Package:

- "Mini" package
- Assembly height is 17 mm
- Insulated base plate
- Pins suitable for wave soldering and PCB mounting
- Assembly clips available
  - IXKU 5-505 screw clamp
  - IXRB 5-506 click clamp
- UL registered E72873

## Output Inverter T1 - T6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 150^\circ\text{C}$		1200		V
$V_{GES}$	max. DC gate voltage	continuous		$\pm 20$		V
$V_{GEM}$	max. transient collector gate voltage	transient		$\pm 30$		V
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$	29		A	
$I_{C80}$		$T_C = 80^\circ\text{C}$	20		A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$	100		W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 15 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.7 2.0	2.2	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.5 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	5	5.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.6	mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 \text{ V}$			150	nA
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		1100		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 15 \text{ A}$		92		nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 25^\circ\text{C}$ $V_{CE} = 600 \text{ V}; I_C = 15 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 75 \Omega$	55		ns	
$t_r$	current rise time		30		ns	
$t_{d(off)}$	turn-off delay time		320		ns	
$t_f$	current fall time		200		ns	
$E_{on}$	turn-on energy per pulse		1.2		mJ	
$E_{off}$	turn-off energy per pulse		1.3		mJ	
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 600 \text{ V}; I_C = 15 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 75 \Omega$	60		ns	
$t_r$	current rise time		35		ns	
$t_{d(off)}$	turn-off delay time		360		ns	
$t_f$	current fall time		340		ns	
$E_{on}$	turn-on energy per pulse		2		mJ	
$E_{off}$	turn-off energy per pulse		1.7		mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15 \text{ V}; R_G = 75 \Omega; I_C = 30 \text{ A}; T_{VJ} = 125^\circ\text{C}$	$V_{CEK} \leq V_{CES} \cdot L_S \cdot d_I/dt$			V
<b>I<sub>sc</sub> (SCSOA)</b>	short circuit safe operating area	$V_{CE} = 720 \text{ V}; V_{GE} = \pm 15 \text{ V}; T_{VJ} = 125^\circ\text{C}$ $R_G = 75 \Omega; t_p = 10 \mu\text{s}$ ; non-repetitive	68			A
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			1.2	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.4		K/W

## Output Inverter D1 - D6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$		1200		V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$	24		A	
$I_{F80}$		$T_C = 80^\circ\text{C}$	16		A	
$V_F$	forward voltage	$I_F = 15 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.3 1.9	2.7	V
$Q_{rr}$	reverse recovery charge	$T_{VJ} = 125^\circ\text{C}$ $V_R = 600 \text{ V}$ $di_F/dt = -420 \text{ A}/\mu\text{s}$ $I_F = 15 \text{ A}; V_{GE} = 0 \text{ V}$	2.3		$\mu\text{C}$	
$I_{RM}$	max. reverse recovery current		19.6		A	
$t_{rr}$	reverse recovery time		330		ns	
$E_{rec}$	reverse recovery energy		0.68		mJ	
$R_{thJC}$	thermal resistance junction to case	(per diode)			1.6	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.55		K/W

 $T_C = 25^\circ\text{C}$  unless otherwise stated

IXYS reserves the right to change limits, test conditions and dimensions.

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## Brake T7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 150^\circ\text{C}$			1200	V
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$			29	A
$I_{C80}$		$T_C = 80^\circ\text{C}$			20	A
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$			100	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 15 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.7 2.0	2.2	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.5 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	5	5.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.6	mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 \text{ V}$			150	nA
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		1100		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 15 \text{ A}$		92		nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 25^\circ\text{C}$ $V_{CE} = 600 \text{ V}; I_C = 15 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 75 \Omega$	55			ns
$t_r$	current rise time		30			ns
$t_{d(off)}$	turn-off delay time		320			ns
$t_f$	current fall time		200			ns
$E_{on}$	turn-on energy per pulse		1.0			mJ
$E_{off}$	turn-off energy per pulse		1.3			mJ
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 600 \text{ V}; I_C = 15 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 75 \Omega$	60			ns
$t_r$	current rise time		35			ns
$t_{d(off)}$	turn-off delay time		360			ns
$t_f$	current fall time		340			ns
$E_{on}$	turn-on energy per pulse		1.6			mJ
$E_{off}$	turn-off energy per pulse		1.7			mJ
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15 \text{ V}; R_G = 75 \Omega; I_C = 30 \text{ A}; T_{VJ} = 125^\circ\text{C}$	$V_{CEK} \leq V_{CES} \cdot L_S \cdot d_I / dt$			V
<b>I<sub>sc</sub> (SCSOA)</b>	short circuit safe operating area	$V_{CE} = 720 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 75 \Omega; t_p = 10 \mu\text{s}$ ; non-repetitive	$T_{VJ} = 125^\circ\text{C}$	68		A
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			1.2	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.4		K/W

## Brake Chopper D7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$			1200	V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$			15	A
$I_{F80}$		$T_C = 80^\circ\text{C}$			10	A
$V_F$	forward voltage	$I_F = 15 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	3.0 2.4	3.3	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.2	0.1	mA
$Q_{rr}$	reverse recovery charge	$T_{VJ} = 125^\circ\text{C}$ $V_R = 600 \text{ V}$ $di_F/dt = tbd \text{ A}/\mu\text{s}$ $I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$	tbd			$\mu\text{C}$
$I_{RM}$	max. reverse recovery current		tbd			A
$t_{rr}$	reverse recovery time		tbd			ns
$E_{rec}$	reverse recovery energy		tbd			$\mu\text{J}$
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.5	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.85		K/W

 $T_C = 25^\circ\text{C}$  unless otherwise stated

IXYS reserves the right to change limits, test conditions and dimensions.

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**Input Rectifier Bridge D8 - D11**

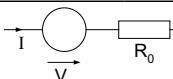
<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 25^\circ\text{C}$		1600	V
$I_{FAV}$	average forward current	sine 180°	$T_C = 80^\circ\text{C}$		22	A
$I_{DAVM}$	max. average DC output current	rect.; $d = 1/3$	$T_C = 80^\circ\text{C}$		61	A
$I_{FSM}$	max. forward surge current	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		300 tbd	A A
$I^2t$	$I^2t$ value for fusing	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		450 tbd	$\text{A}^2\text{s}$ $\text{A}^2\text{s}$
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		50	W
$V_F$	forward voltage	$I_F = 30 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.35 1.35	1.6	V V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.01 0.3	mA mA	
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.1	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per diode)			0.7	K/W

**Temperature Sensor NTC**

<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$R_{25}$	resistance		$T_C = 25^\circ\text{C}$	4.75	5.0	$\text{k}\Omega$
$B_{25/50}$					3375	K

**Module**

<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$T_{VJ}$	operating temperature		-40		125	$^\circ\text{C}$
$T_{VJM}$	max. virtual junction temperature				150	$^\circ\text{C}$
$T_{stg}$	storage temperature		-40		125	$^\circ\text{C}$
$V_{ISOL}$	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
<b>CTI</b>	comparative tracking index				-	
$F_c$	mounting force		40		80	N
$d_s$	creep distance on surface		12.7			mm
$d_A$	strike distance through air		12			mm
<b>Weight</b>				35		g

**Equivalent Circuits for Simulation**

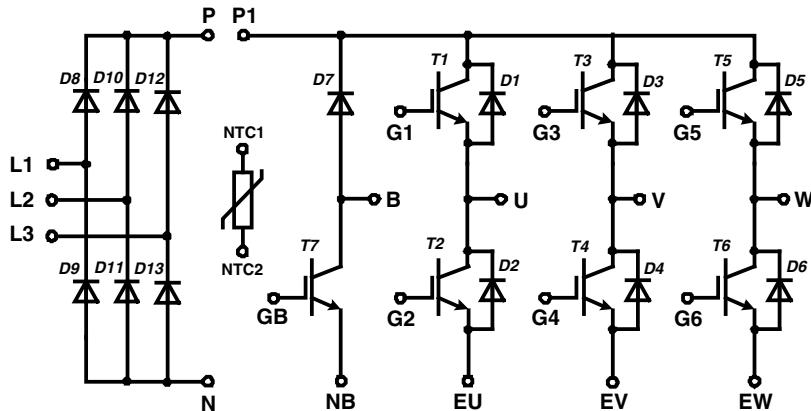
<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$V_0$	rectifier diode	D8 - D13	$T_{VJ} = 125^\circ\text{C}$	0.9 16		V $\text{m}\Omega$
$R_0$						
$V_0$	IGBT	T1 - T6	$T_{VJ} = 125^\circ\text{C}$	1.0 67		V $\text{m}\Omega$
$R_0$						
$V_0$	free wheeling diode	D1 - D6	$T_{VJ} = 125^\circ\text{C}$	1.15 50		V $\text{m}\Omega$
$R_0$						
$V_0$	IGBT	T7	$T_{VJ} = 125^\circ\text{C}$	1.0 67		V $\text{m}\Omega$
$R_0$						
$V_0$	free wheeling diode	D7	$T_{VJ} = 125^\circ\text{C}$	1.6 53		V $\text{m}\Omega$
$R_0$						

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 $T_C = 25^\circ\text{C}$  unless otherwise stated

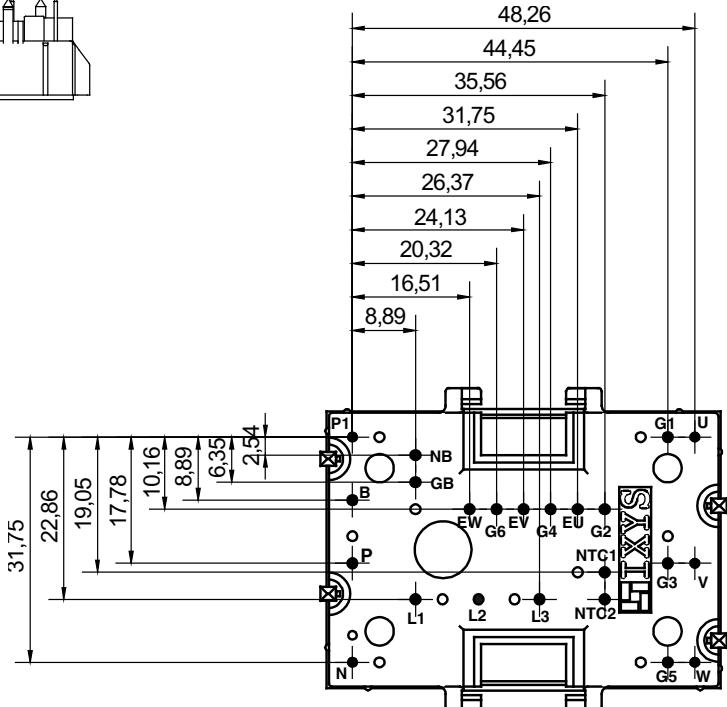
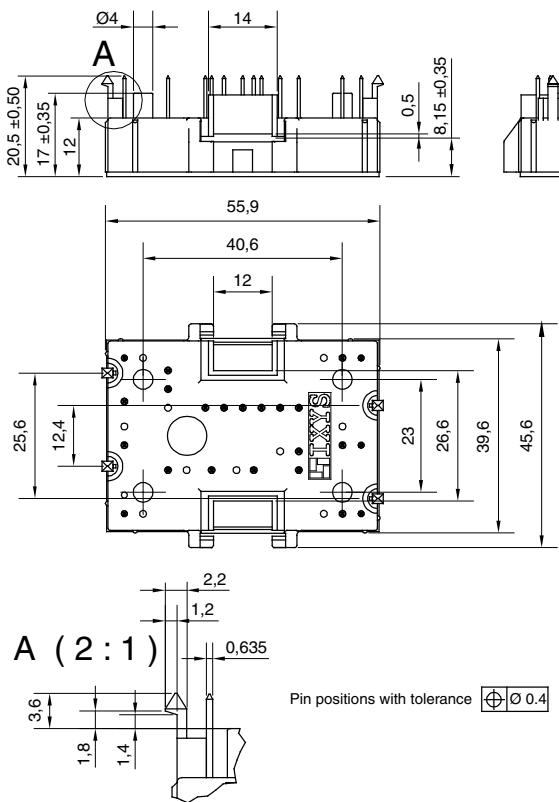
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## Circuit Diagram

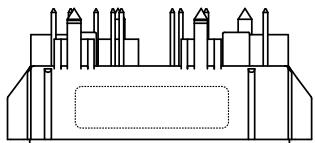


## Outline Drawing

Dimensions in mm (1 mm = 0.0394")



## Product Marking



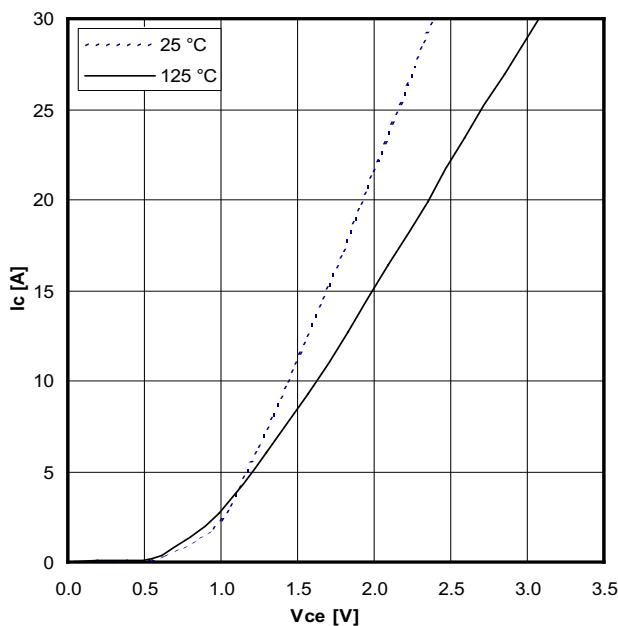
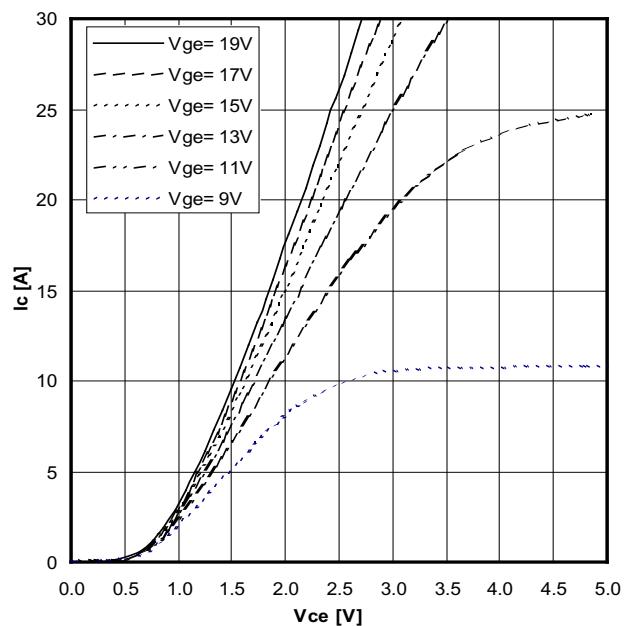
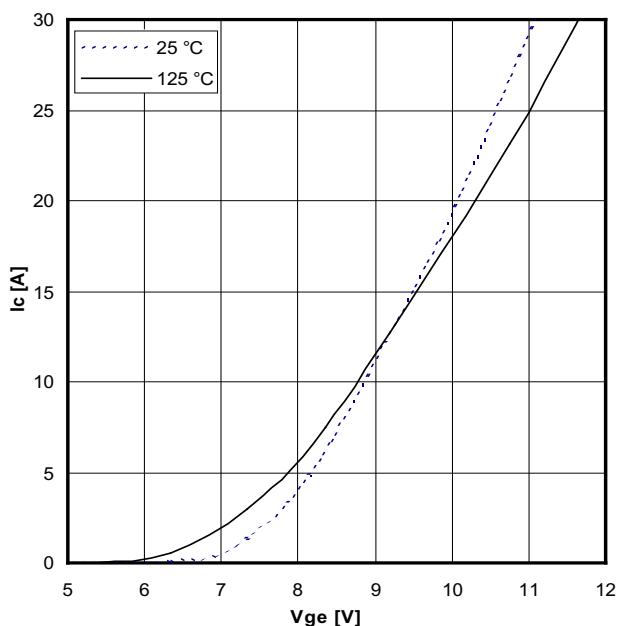
## Part number

M = Module  
 I = IGBT  
 T = Trench  
 A = Gen<sup>2</sup> / low loss  
 10 = Current Rating [A]  
 WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit  
 1200 = Reverse Voltage [V]  
 T = NTC  
 MH = MiniPack2

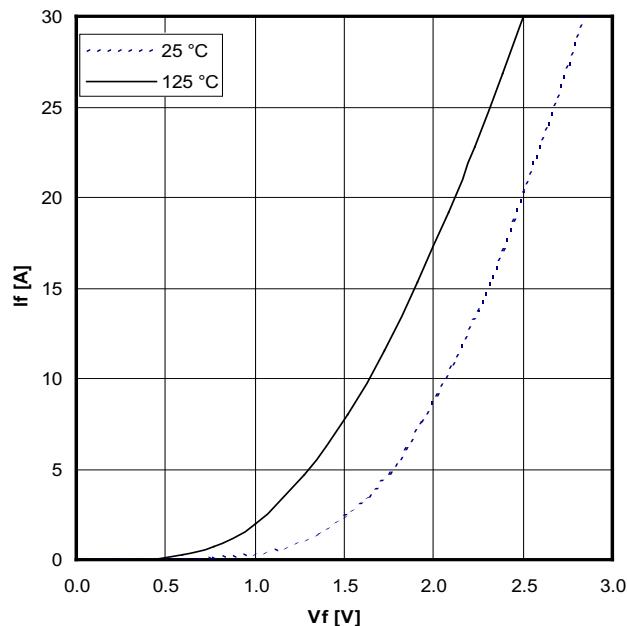
Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MITB 15 WB 1200 TMH	MITB15WB1200TMH	Box	20	502893

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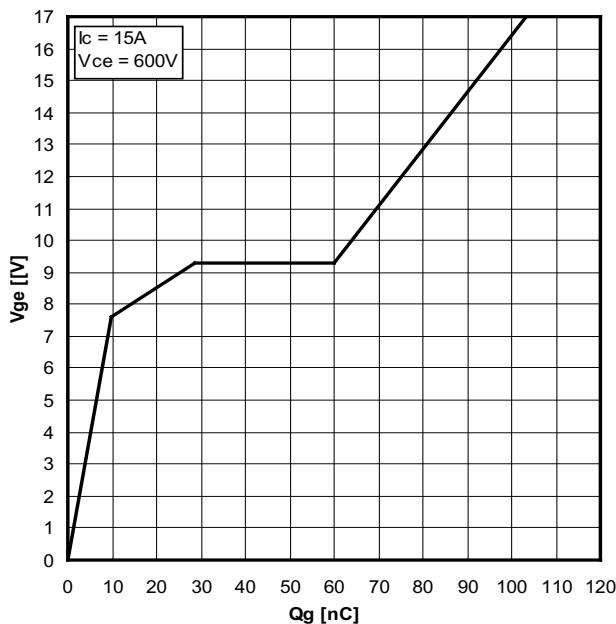
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 Typical output characteristics,  $V_{GE} = 15$  V

 Typical output characteristics ( $125^\circ C$ )


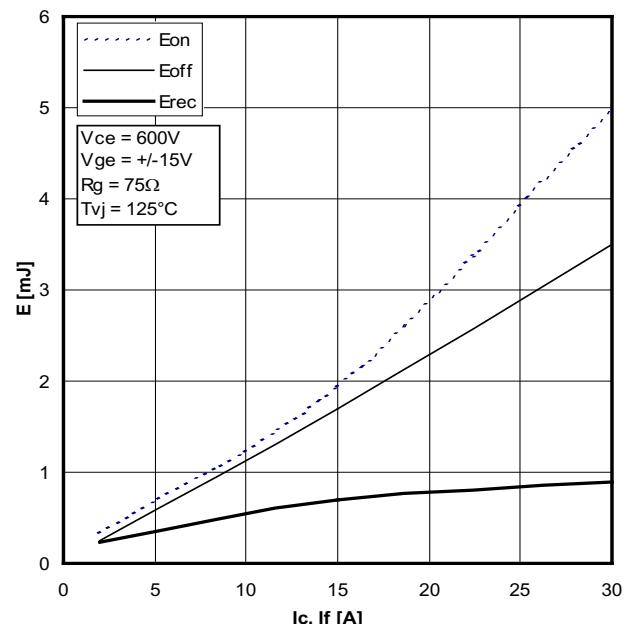
Typical transfer characteristics



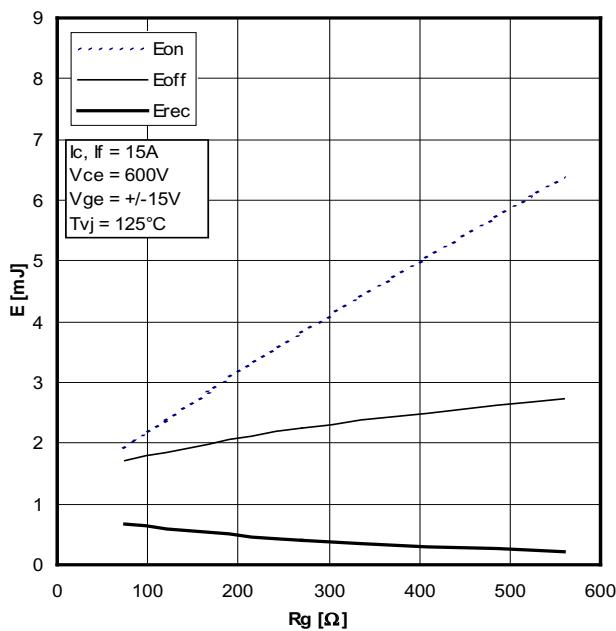
Typical forward characteristics of freewheeling diode



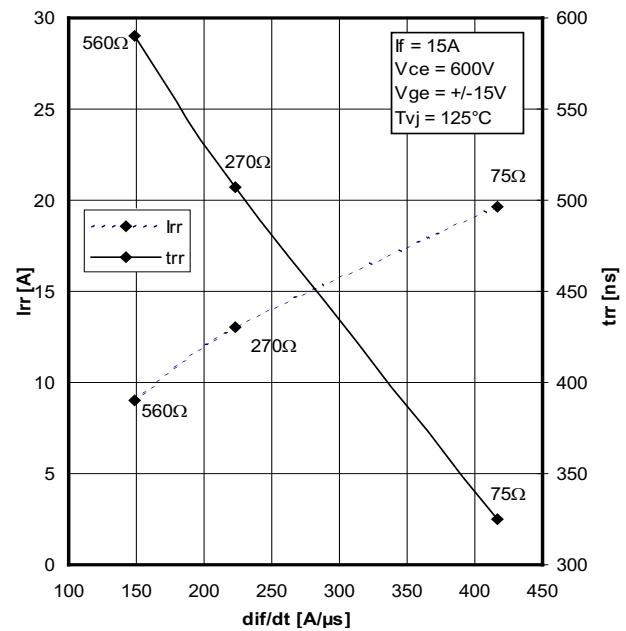
Typical turn on gate charge



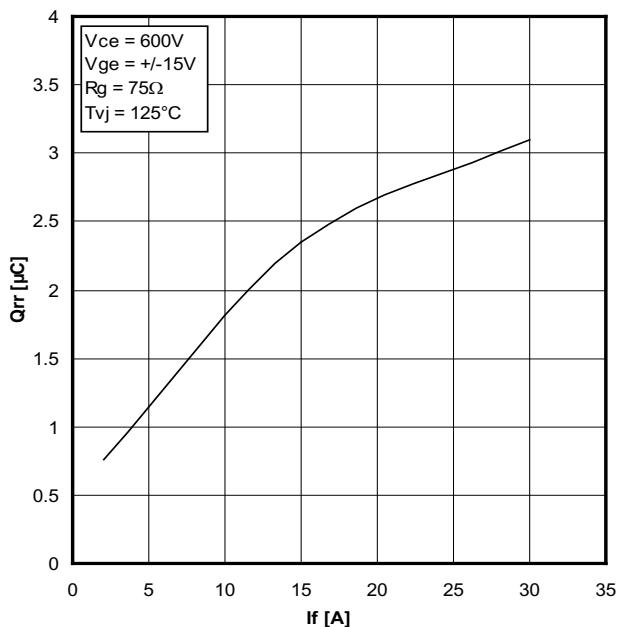
Typical switching energy versus collector current



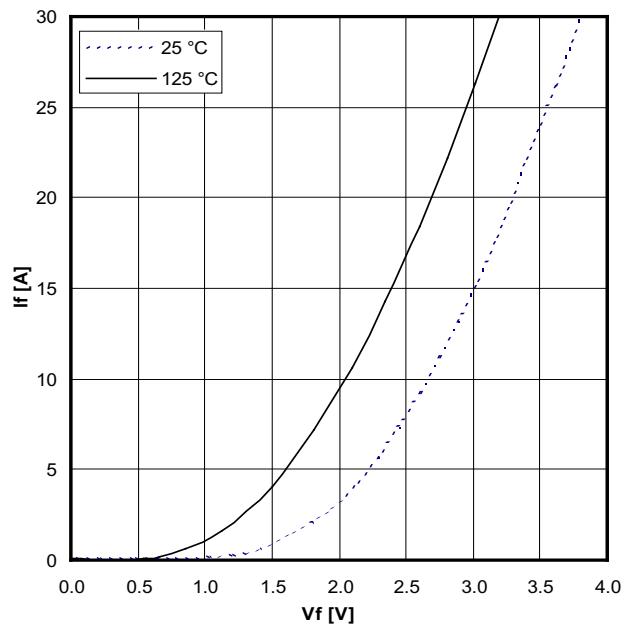
Typical switching energy versus gate resistance



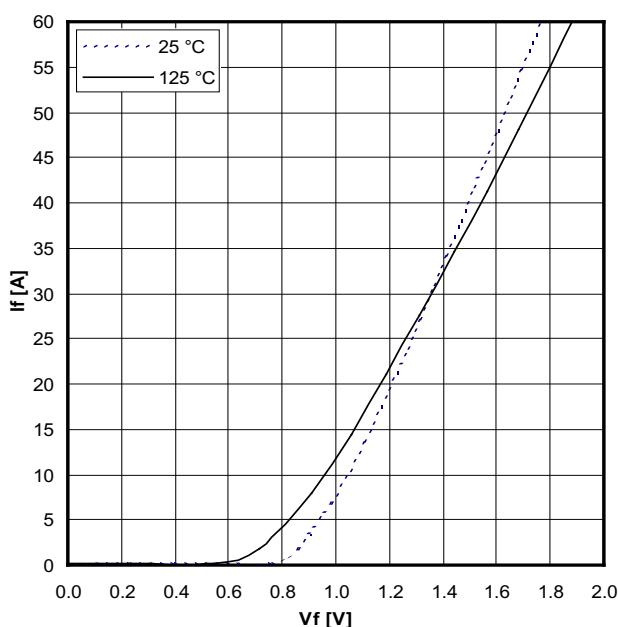
Typical turn-off characteristics of free wheeling diode



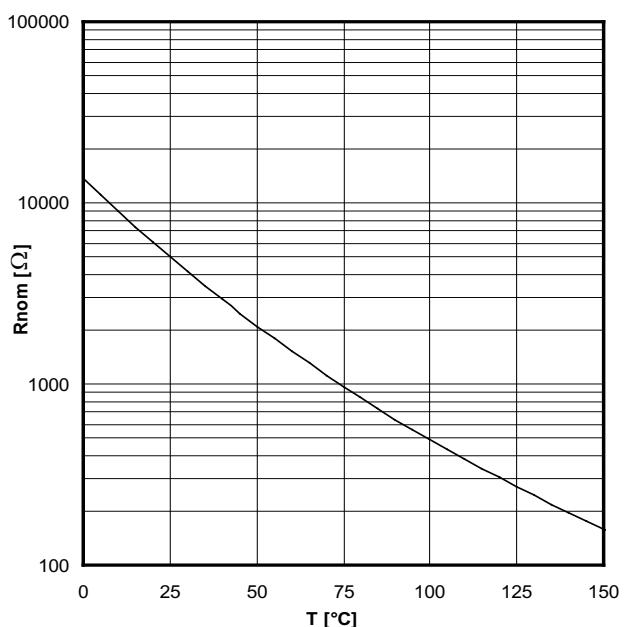
Typical turn-off characteristics of free wheeling diode



Typical forward characteristics of brake diode



Typical forward characteristics per rectifier



Typical thermistor resistance versus temperature